



Final Product Change Notification

201704014F01

Issue Date: 30-Apr-2017
Effective Date: 14-Jun-2017

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QUALITY

Management Summary

Critical capacity constraints at NXP ATTJ Tianjin, China test site dictates the expansion / relocation of the MST Final Test Platform to KESM Industries Tianjin, China for supply assurance.

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |

MST Final Test Platform Expansion / Relocation from ATTJ to KESM

Details of this Change

NXP Semiconductors announces the MST Final Test Platform expansion / relocation for the Automotive devices associated with this notification. MST test systems relocate from the current NXP ATTJ Tianjin, China test site to the KESM Industries Tianjin, China test site. Additional floor space is required at the current ATTJ site for newer / more complex test platform expansions, and results in the accelerated relocation of the legacy MST test platform and associated hardware to KESM.

Please see the attached summary for additional details.

Why do we Implement this Change

Qualification of KESM Industries Tianjin, China is required for customer supply assurance.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Not applicable

Production

Planned first shipment 30-Jun-2017

Impact

No impact to form, fit, function or reliability.

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 30-May-2017.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Jay Woodruff
Position Change Management
e-mail address jay.woodruff@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
MC33883HEGR2	935311765518	MC33883HEGR2	FULL BRIDGE GATE DRIVER	SO20	RFS	BL Advanced Automotive Analog
MC33879APEKR2	935317184518	MC33879APEK	CONFIG OCTAL SERIAL SW	HSOP32	RFS	BL Advanced Automotive Analog
MC33887APVWR2	935317171518	MC33887APVWR2	H-BRIDGE W/LD CURNT FDBK	HSOP20	RFS	BL Advanced Automotive Analog
MM912KS812AMAF	935314651557	MM912KS812AMAF	IGN, INJ DRIVER 12XS256K	HLQFP100	RFS	BL Advanced Automotive Analog
MC33886PVW	935321438574	MC33886PVW	5.0 A H-BRIDGE	HSOP20	RFS	BL Advanced Automotive Analog
MCZ33996EKR2	935313689518	MCZ33996EKR2	16 LOW SIDE SW 1.20HM	HSOP32	RFS	BL Advanced Automotive Analog
MC33975TEK	935315721574	MC33975TEK	MULTI SW DETECT INTERFAC	SSOP32	RFS	BL Advanced Automotive Analog
MC33972ATEWR2	935310479518	MC33972ATEW	MULT SW DET SUP-WKUP	SSOP32	RFS	BL Advanced Automotive Analog
MCZ33996EK	935313689574	MCZ33996EK	16 LOW SIDE SW 1.20HM	HSOP32	RFS	BL Advanced Automotive Analog
MC33886PVWR2	935321438518	MC33886PVWR2	5.0 A H-BRIDGE	HSOP20	RFS	BL Advanced Automotive Analog
MC33972ATEW	935310479574	MC33972ATEW	MULT SW DET SUP-WKUP	SSOP32	RFS	BL Advanced Automotive Analog
MC33879APEK	935317184574	MC33879APEK	CONFIG OCTAL SERIAL SW	HSOP32	RFS	BL Advanced Automotive Analog
MC33797BPEW	935310211574	MC33797BPEW	Four Channel Squib Dr	SSOP32	RFS	BL Advanced Automotive Analog
MC33887APVW	935317171574	MC33887APVW	H-BRIDGE W/LD CURNT FDBK	HSOP20	RFS	BL Advanced Automotive Analog
MCZ33810EK	935315289574	MCZ33810EK	Ignition Injector Driver	HSOP32	RFS	BL Advanced Automotive Analog